

OCENME

OSP8N65C / OSF8N65C 650V N-Channel MOSFET

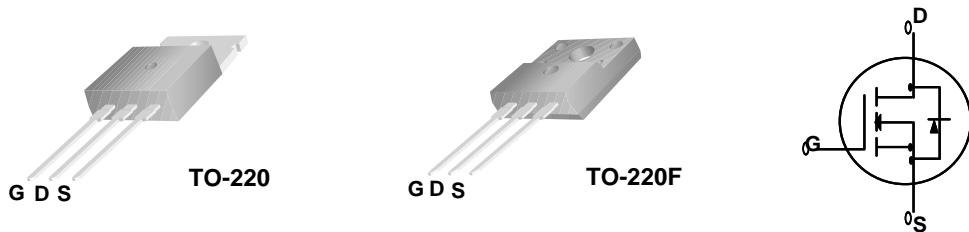
General Description

This Power MOSFET is produced using ocenme's advanced planar stripe DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switched mode power supplies, active power factor correction based on half bridge topology.

Features

- 7.5A, 650V, $R_{DS(on)} = 1.60\Omega$ @ $V_{GS} = 10\text{ V}$
- Low gate charge (typical 29nC)
- High ruggedness
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability



Absolute Maximum Ratings

$T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	OSP8N65C	OSF8N65C	Units	
V_{DSS}	Drain-Source Voltage	650		V	
I_D	Drain Current - Continuous ($T_C = 25^\circ\text{C}$)	7.5	7.5 *	A	
	- Continuous ($T_C = 100^\circ\text{C}$)	4.5	4.5 *	A	
I_{DM}	Drain Current - Pulsed	(Note 1)	30	30 *	A
V_{GSS}	Gate-Source Voltage		± 30	V	
E_{AS}	Single Pulsed Avalanche Energy	(Note 2)	260	mJ	
E_{AR}	Repetitive Avalanche Energy	(Note 1)	14.7	mJ	
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	4.5	V/ns	
P_D	Power Dissipation ($T_C = 25^\circ\text{C}$)	147	48	W	
	- Derate above 25°C	1.18	0.38	$\text{W}/^\circ\text{C}$	
T_J, T_{STG}	Operating and Storage Temperature Range		-55 to +150	$^\circ\text{C}$	
T_L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	$^\circ\text{C}$	

* Drain current limited by maximum junction temperature.

Thermal Characteristics

Symbol	Parameter	OSP8N65C	OSF8N65C	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	0.85	2.6	$^\circ\text{C}/\text{W}$
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink Typ.	0.5	--	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	62.5	62.5	$^\circ\text{C}/\text{W}$

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Electrical Characteristics

$T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
Off Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}} = 0 \text{ V}, I_D = 250 \mu\text{A}$	650	--	--	V
$\Delta \text{BV}_{\text{DSS}} / \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu\text{A}$, Referenced to 25°C	--	0.7	--	$\text{V}/^\circ\text{C}$
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}} = 650 \text{ V}, V_{\text{GS}} = 0 \text{ V}$	--	--	1	μA
		$V_{\text{DS}} = 520 \text{ V}, T_C = 125^\circ\text{C}$	--	--	10	μA
I_{GSSF}	Gate-Body Leakage Current, Forward	$V_{\text{GS}} = 30 \text{ V}, V_{\text{DS}} = 0 \text{ V}$	--	--	100	nA
I_{GSSR}	Gate-Body Leakage Current, Reverse	$V_{\text{GS}} = -30 \text{ V}, V_{\text{DS}} = 0 \text{ V}$	--	--	-100	nA
On Characteristics						
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250 \mu\text{A}$	2.0	--	4.5	V
$R_{\text{DS(on)}}$	Static Drain-Source On-Resistance	$V_{\text{GS}} = 10 \text{ V}, I_D = 3.75 \text{ A}$	--	1.2	1.6	Ω
Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{\text{DS}} = 25 \text{ V}, V_{\text{GS}} = 0 \text{ V}, f = 1.0 \text{ MHz}$	--	1000	--	pF
C_{oss}	Output Capacitance		--	110	--	pF
C_{rss}	Reverse Transfer Capacitance		--	12.6	--	pF
Switching Characteristics						
$t_{\text{d(on)}}$	Turn-On Delay Time	$V_{\text{DD}} = 325 \text{ V}, I_D = 7.5 \text{ A}, R_G = 25 \Omega$ (Note 4, 5)	--	20	--	ns
t_r	Turn-On Rise Time		--	50	--	ns
$t_{\text{d(off)}}$	Turn-Off Delay Time		--	80	--	ns
t_f	Turn-Off Fall Time		--	70	--	ns
Q_g	Total Gate Charge	$V_{\text{DS}} = 520 \text{ V}, I_D = 7.5 \text{ A}, V_{\text{GS}} = 10 \text{ V}$ (Note 4, 5)	--	29	-	nC
Q_{gs}	Gate-Source Charge		--	4.7	--	nC
Q_{gd}	Gate-Drain Charge		--	12.5	--	nC
Drain-Source Diode Characteristics and Maximum Ratings						
I_S	Maximum Continuous Drain-Source Diode Forward Current	--	--	7.5	A	
I_{SM}	Maximum Pulsed Drain-Source Diode Forward Current	--	--	30	A	
V_{SD}	Drain-Source Diode Forward Voltage	$V_{\text{GS}} = 0 \text{ V}, I_S = 7.5 \text{ A}$	--	--	1.4	V
t_{rr}	Reverse Recovery Time	$V_{\text{GS}} = 0 \text{ V}, I_S = 7.5 \text{ A}, dI_F / dt = 100 \text{ A}/\mu\text{s}$ (Note 4)	--	350	--	ns
Q_{rr}	Reverse Recovery Charge		--	3.3	--	μC

Notes:

1. Repetitive Rating : Pulse width limited by maximum junction temperature
2. $L = 10 \text{ mH}, I_{\text{AS}} = 7.5 \text{ A}, V_{\text{DD}} = 50 \text{ V}, R_G = 25 \Omega$, Starting $T_J = 25^\circ\text{C}$
3. $I_{\text{Sp}} \leq 7.5 \text{ A}, dV/dt \leq 200 \text{ V}/\mu\text{s}$, Starting $T_J = 25^\circ\text{C}$
4. Pulse Test : Pulse width $\leq 300 \mu\text{s}$, Duty cycle $\leq 2\%$
5. Essentially independent of operating temperature

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Typical Characteristics

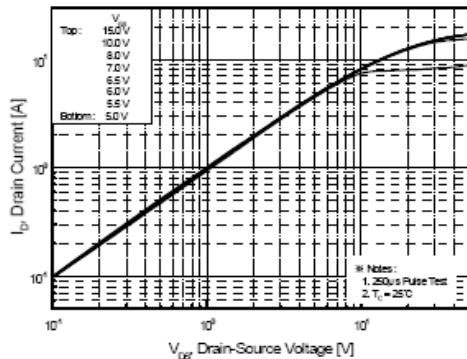


Figure 1. On-Region Characteristics

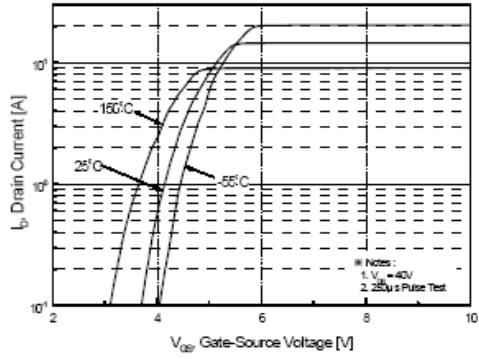


Figure 2. Transfer Characteristics

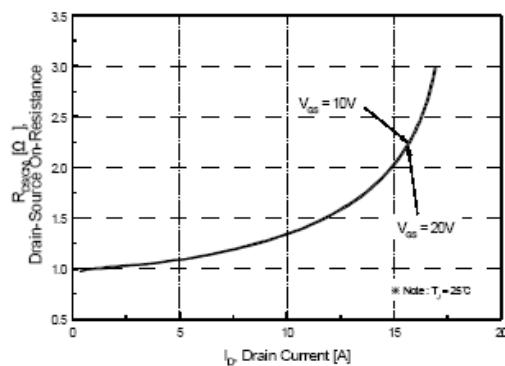


Figure 3. On-Resistance Variation vs Drain Current and Gate Voltage

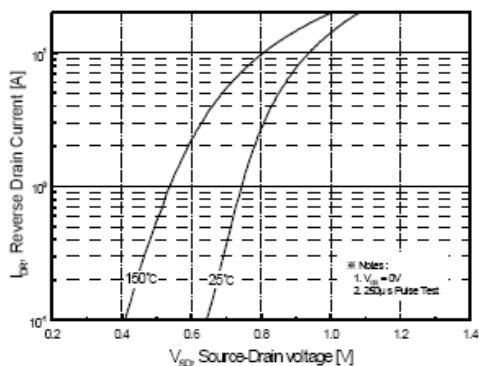


Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature

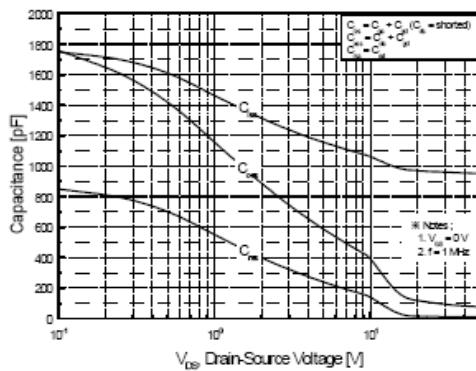


Figure 5. Capacitance Characteristics

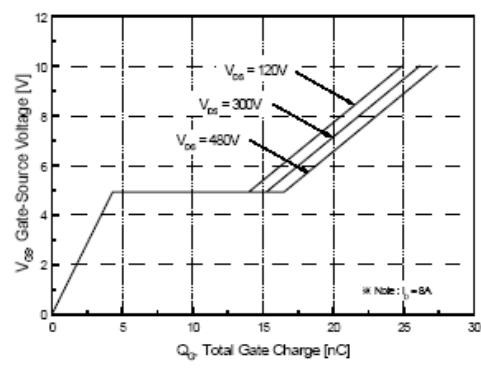


Figure 6. Gate Charge Characteristics

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Typical Characteristics (Continued)

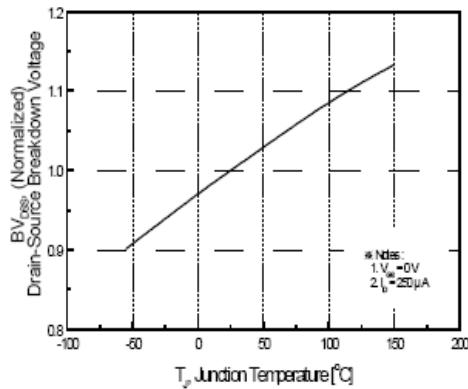


Figure 7. Breakdown Voltage Variation vs Temperature

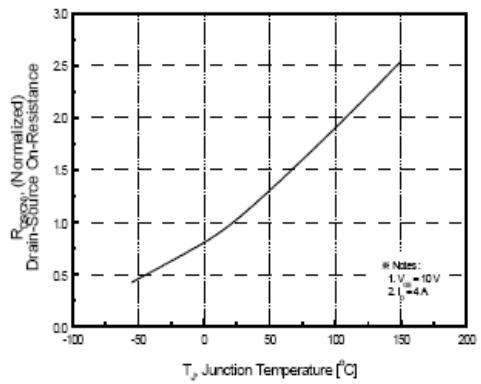


Figure 8. On-Resistance Variation vs Temperature

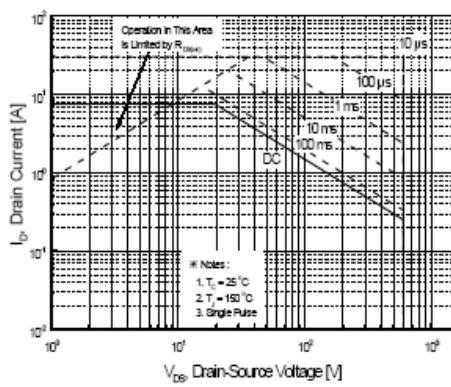


Figure 9-1. Maximum Safe Operating Area for OSP8N65C

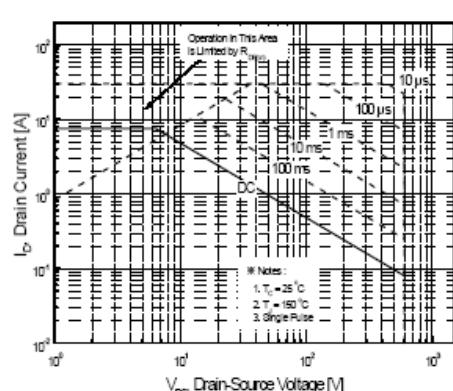


Figure 9-2. Maximum Safe Operating Area for OSF8N65C

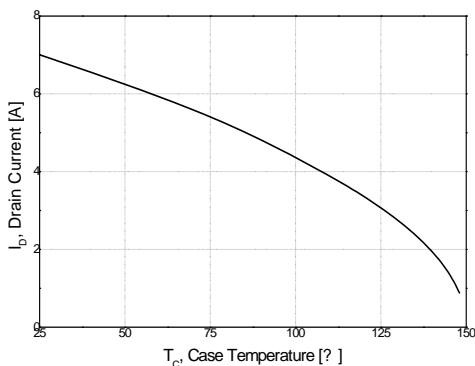


Figure 10. Maximum Drain Current vs Case Temperature

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Typical Characteristics (Continued)

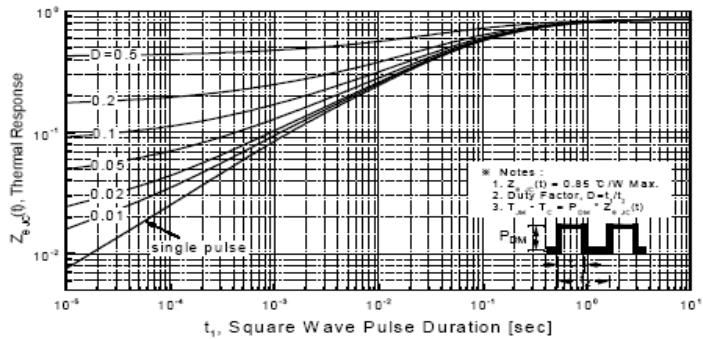


Figure 11-1. Transient Thermal Response Curve
for OSP8N65C

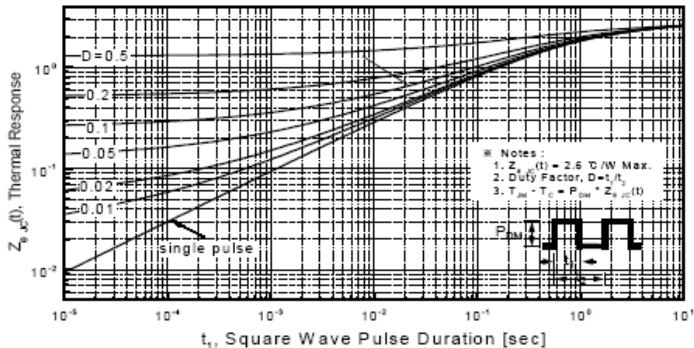
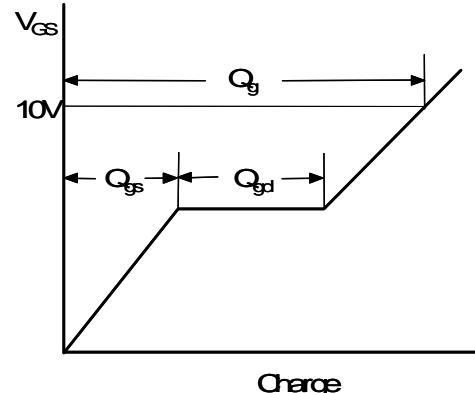
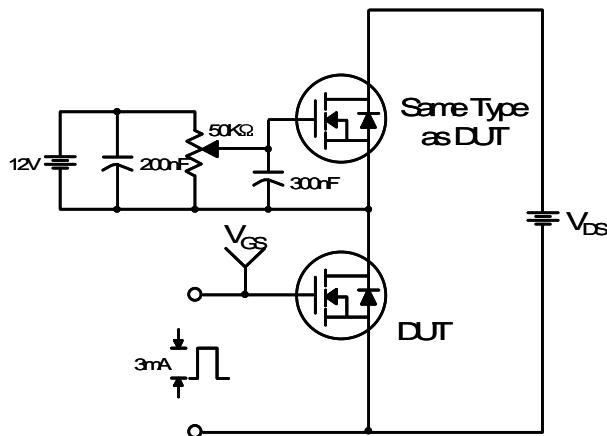


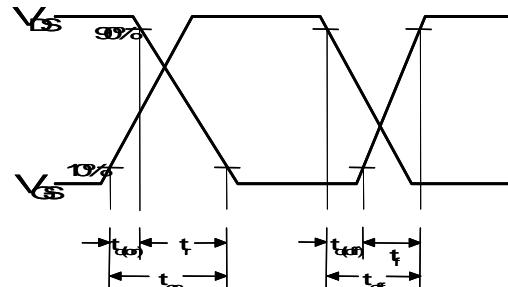
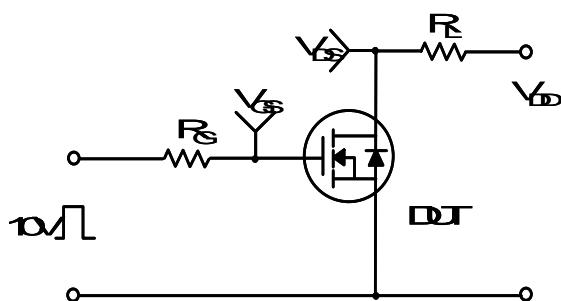
Figure 11-2. Transient Thermal Response Curve
for OSF8N65C

OSP8N65C / OSF8N65C

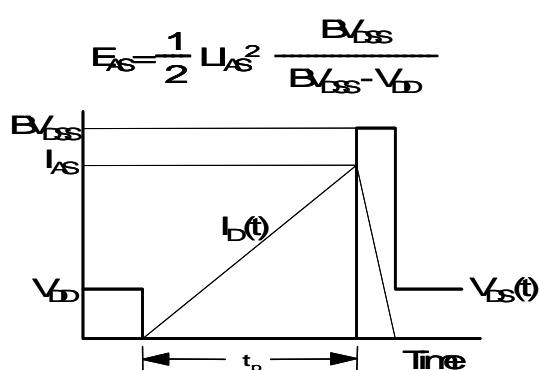
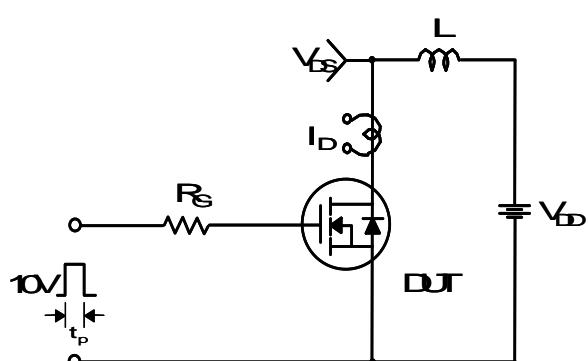
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching Test Circuit & Waveforms



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Peak Diode Recovery dv/dt Test Circuit & Waveforms

